IS31FL3733A

12×16 DOTS MATRIX LED DRIVER WITH INDIVIDUAL AUTO BREATH FUNCTION

August 2020

GENERAL DESCRIPTION

The IS31FL3733A is a general purpose 12×16 LEDs matrix driver with 1/12 cycle rate. The device can be programmed via an I2C compatible interface. Each LED can be dimmed individually with 8-bit PWM data which allowing 256 steps of linear dimming.

IS31FL3733A features 3 Auto Breathing Modes which are noted as ABM-1, ABM-2 and ABM-3. For each Auto Breathing Mode, there are 4 timing characters which include current rising / holding / falling / off time and 3 loop characters which include Loop-Beginning / Loop-Ending / Loop-Times. Every LED can be configured to be any Auto Breathing Mode or No-Breathing Mode individually.

Additionally each LED open and short state can be detected, IS31FL3733A store the open or short information in Open-Short Registers. The Open-Short Registers allowing MCU to read out via I2C compatible interface. Inform MCU whether there are LEDs open or short and the locations of open or short LEDs.

The IS31FL3733A operates from 2.7V to 5.5V and features a very low shutdown and operational current.

IS31FL3733A is available in QFN-48 (6mm×6mm) and eTQFP-48 packages. It operates from 2.7V to 5.5V over the temperature range of -40°C to +125°C.

FEATURES

- Supply voltage range: 2.7V to 5.5V
- 16 current source outputs for row control
- 12 switch current inputs for column scan control
- Up to 192 LEDs (12×16) in dot matrix
- Programmable 12×16 (64 RGBs) matrix size with de-ghost function
- 1MHz I2C-compatible interface
- Selectable 3 Auto Breath Modes for each dot
- Auto Breath Loop Features interrupt pin inform MCU Auto Breath Loop completed
- Auto Breath offers 128 steps gamma current, interrupt and state look up registers
- 7.4kHz/25kHz PWM frequency option
- 256 steps Global Current Setting
- Individual on/off control
- Individual 256 PWM control steps
- Individual Auto Breath Mode select
- Individual open and short error detect function
- Cascade for synchronization of chips
- QFN-48 (6mm×6mm) and eTQFP-48 packages

APPLICATIONS

- Hand-held devices for LED display
- Gaming device (Keyboard, Mouse etc.)
- LED in white goods application

TYPICAL APPLICATION CIRCUIT

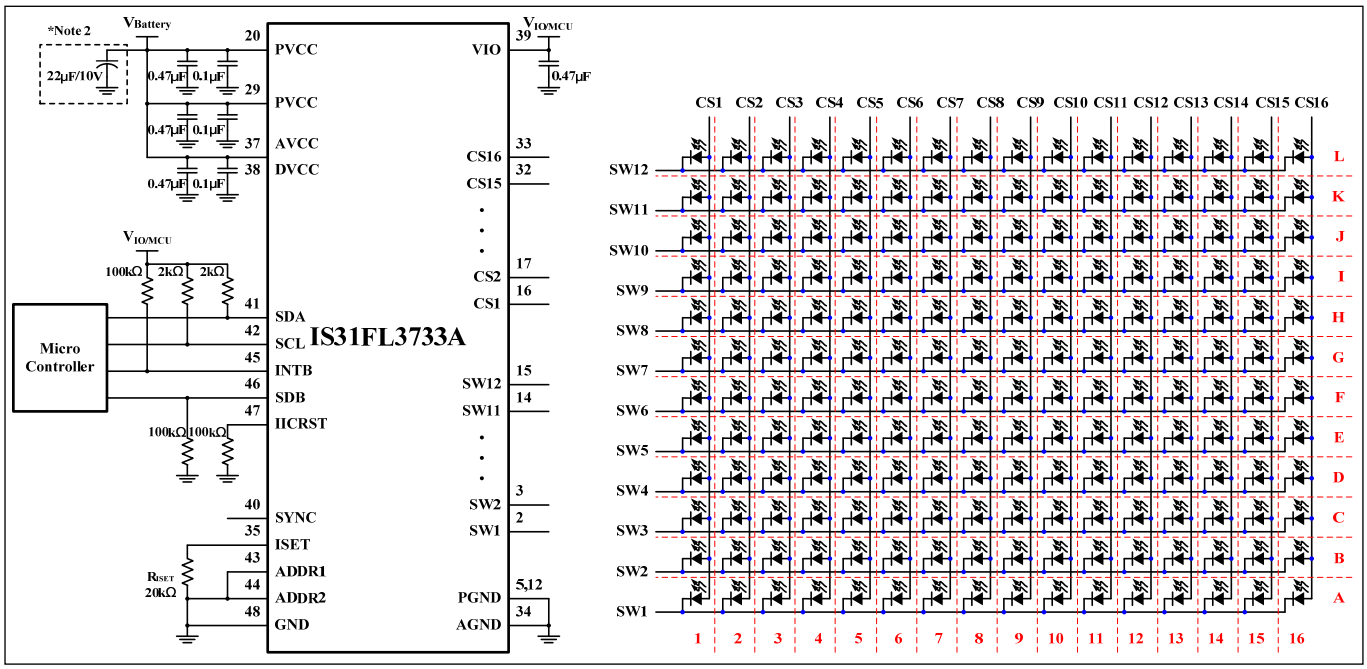


Figure 1 Typical Application Circuit (12×16)

TYPICAL APPLICATION CIRCUIT (CONTINUED)

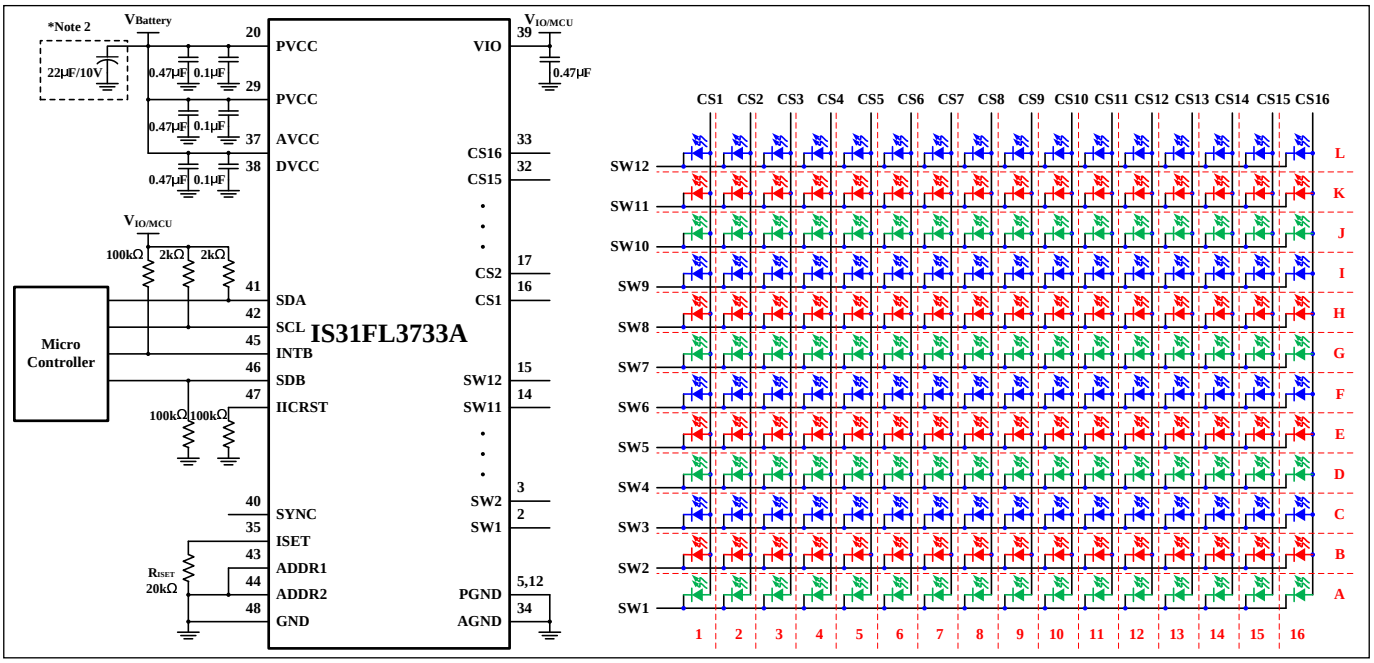


Figure 2 Typical Application Circuit (RGB)

Note 1: IC should be placed far away from the antenna in order to prevent the EMI.

Note 2: Electrolytic/Tantalum Capacitor maybe considered for high current application to avoid audible noise interference.

Note 3: The VIO should be 1.8V≤ V_{IO} ≤V_{CC}. And it is recommended to be equal to V_{OH} of the micro controller. For example, if V_{OH}=1.8V, set V_{IO}=1.8V, if V_{OH}=3.3V, set V_{IO}=3.3V.

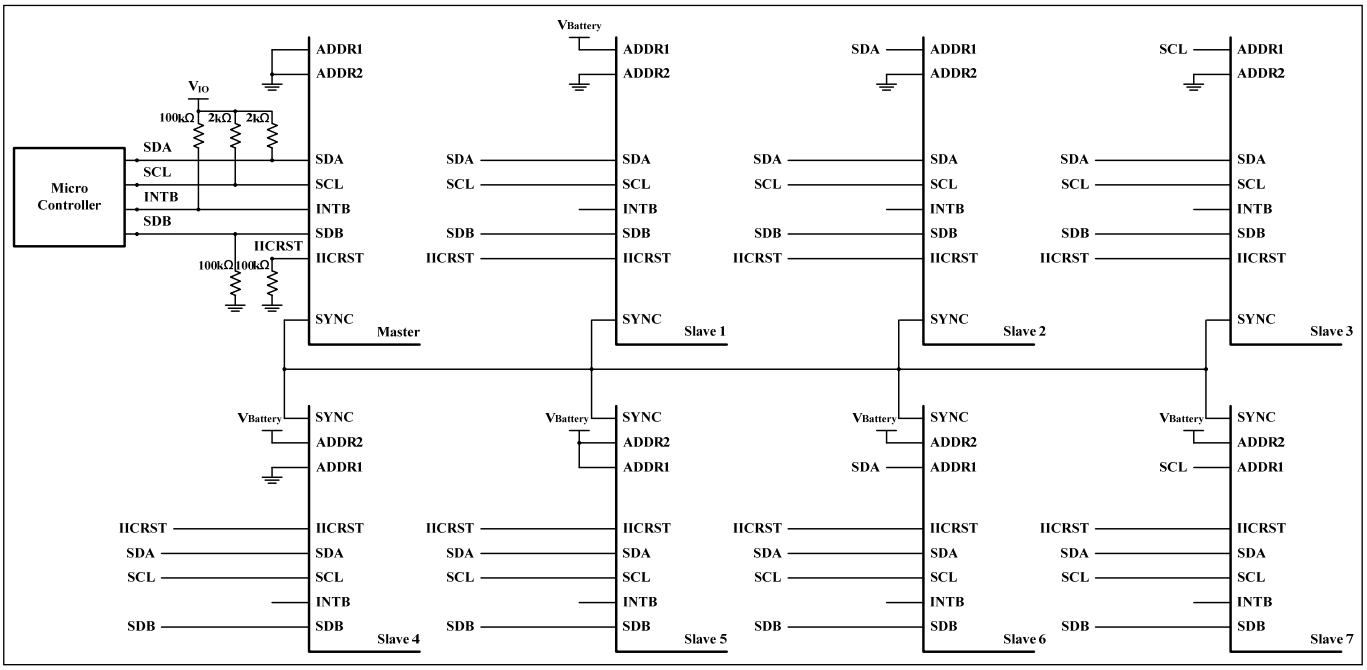
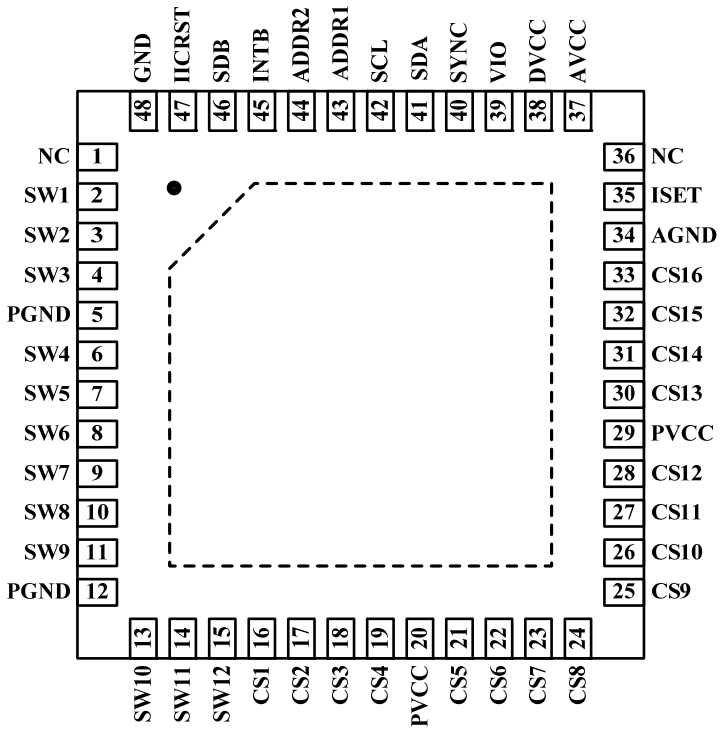
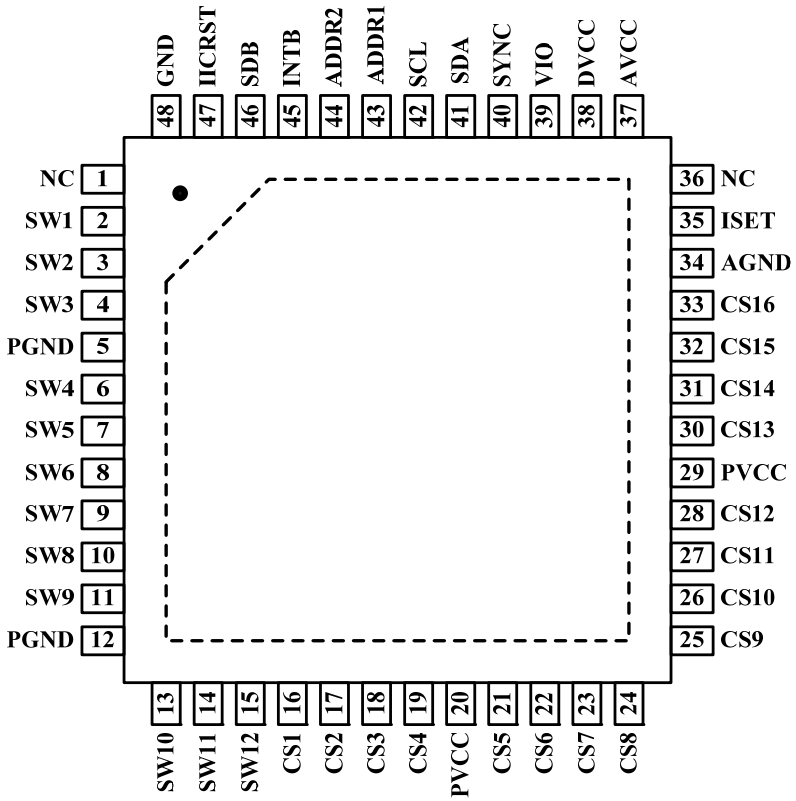


Figure 3 Typical Application Circuit (Eight Parts Synchronization-Work)

Note 4: One system should contain only one master, all slave parts should be configured as slave mode before the master is configured as master mode. Work as master mode or slave mode specified by Configuration Register (Function register, address 00h). Master part output master clock, and all the other parts which work as slave input this master clock.

PIN CONFIGURATION

Package	Pin Configuration (Top View)
QFN-48	
eTQFP-48	

PIN DESCRIPTION

No.	Pin	Description
1,36	NC	Not connect.
2~4,6~11, 13~15	SW1~SW12	Switch pin for LED matrix scanning.
5,12	PGND	Power GND.
16~19, 21~28, 30~33	CS1~CS16	Current Source.
20, 29	PVCC	Power for current source.
34	AGND	Analog GND.
35	ISET	Input terminal used to connect an external resistor. This regulates current source DC current value.
37	AVCC	Power for analog circuits.
38	DVCC	Power for digital circuits.
39	VIO	Input logic reference voltage.
40	SYNC	Synchronize pin. It is used for more than one part work synchronize. If it is not used please float this pin.
41	SDA	I2C compatible serial data.
42	SCL	I2C compatible serial clock.
43	ADDR1	I2C address setting.
44	ADDR2	I2C address setting.
45	INTB	Interrupt output pin. Register F0h sets the function of the INTB pin and active low when the interrupt event happens. Can be NC (float) if interrupt function no used.
46	SDB	Shutdown the chip when pull to low.
47	IICRST	Reset I2C when pull high, need to pull down when normal operation.
48	GND	Connect to GND.
	Thermal Pad	Need to connect to GND pins.

ORDERING INFORMATION

Industrial Range: -40°C to +125°C

Order Part No.	Package	QTY/Reel
IS31FL3733A-QFLS4-TR	QFN-48, Lead-free	2500
IS31FL3733A-TQLS4-TR	eTQFP-48, Lead-free	

ABSOLUTE MAXIMUM RATINGS

Supply voltage, V_{CC}	-0.3V ~ +6.0V
Voltage at any input pin	-0.3V ~ V_{CC}+0.3V
Maximum junction temperature, T_{JMAX}	+150°C
Storage temperature range, T_{STG}	-65°C ~ +150°C
Operating temperature range, T_A=T_J	-40°C ~ +125°C
Package thermal resistance, junction to ambient (4 layer standard test PCB based on JESD 51-2A), θ_{JA}	37.5°C/W (QFN) 39°C/W (eTQFP)
ESD (HBM) ESD (CDM)	±8kV ±1kV

Note 5: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

The following specifications apply for V_{CC} = 3.6V, T_A = 25°C, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage		2.7		5.5	V
I_{CC}	Quiescent power supply current	V_{SDB}= V_{CC}, all LEDs off		2	3	mA
I_{SD}	Shutdown current	V_{SDB}= 0V		2	5	μA
		V_{SDB}= V_{CC}, Configuration Register written "0000 0000		2	5	
I_{OUT}	Maximum constant current of CS1~CS16	R_{ISET}= 20kΩ	38	42	46	mA
I_{LED}	Average current on each LED I_{LED} = I_{OUT}/12.75	R_{ISET} = 20kΩ, GCC= 255, PWM= 255	3.05	3.29	3.61	mA
V_{HR}	Current sink headroom voltage SW1~SW12	I_{SINK}= 672mA (Note 6,7)		300	400	mV
	Current source headroom voltage CS1~C16	I_{SOURCE}= 42mA (Note 6)		150	200	
t_{SCAN}	Period of scanning	PFS= "0"	115	128	140	μs
		PFS= "1"		37.9		
t_{NOL}	Non-overlap blanking time during scan, the SWy and CSx are all off during this time	PFS= "0"	7.2	8	8.75	μs
		PFS= "1"		2.4		
Logic Electrical Characteristics (SDA, SCL, ADDR1, ADDR2, SYNC, SDB)						
V_{IL}	Logic "0" input voltage	V_{IO}= 3.6V	GND		0.2V_{IO}	V
V_{IH}	Logic "1" input voltage	V_{IO}= 3.6V	0.75V_{IO}		V_{IO}	V
V_{HYS}	Input Schmitt trigger hysteresis	V_{IO}= 3.6V		0.2		V
V_{OL}	Logic "0" output voltage for SYNC	I_{OL}= 8mA			0.4	V
V_{OH}	Logic "1" output voltage for SYNC	I_{OH}= 8mA	0.75V_{IO}			V
I_{IL}	Logic "0" input current	V_{INPUT}= 0V (Note 8)		5		nA
I_{IH}	Logic "1" input current	V_{INPUT}= V_{IO} (Note 8)		5		nA

DIGITAL INPUT SWITCHING CHARACTERISTICS (NOTE 8)

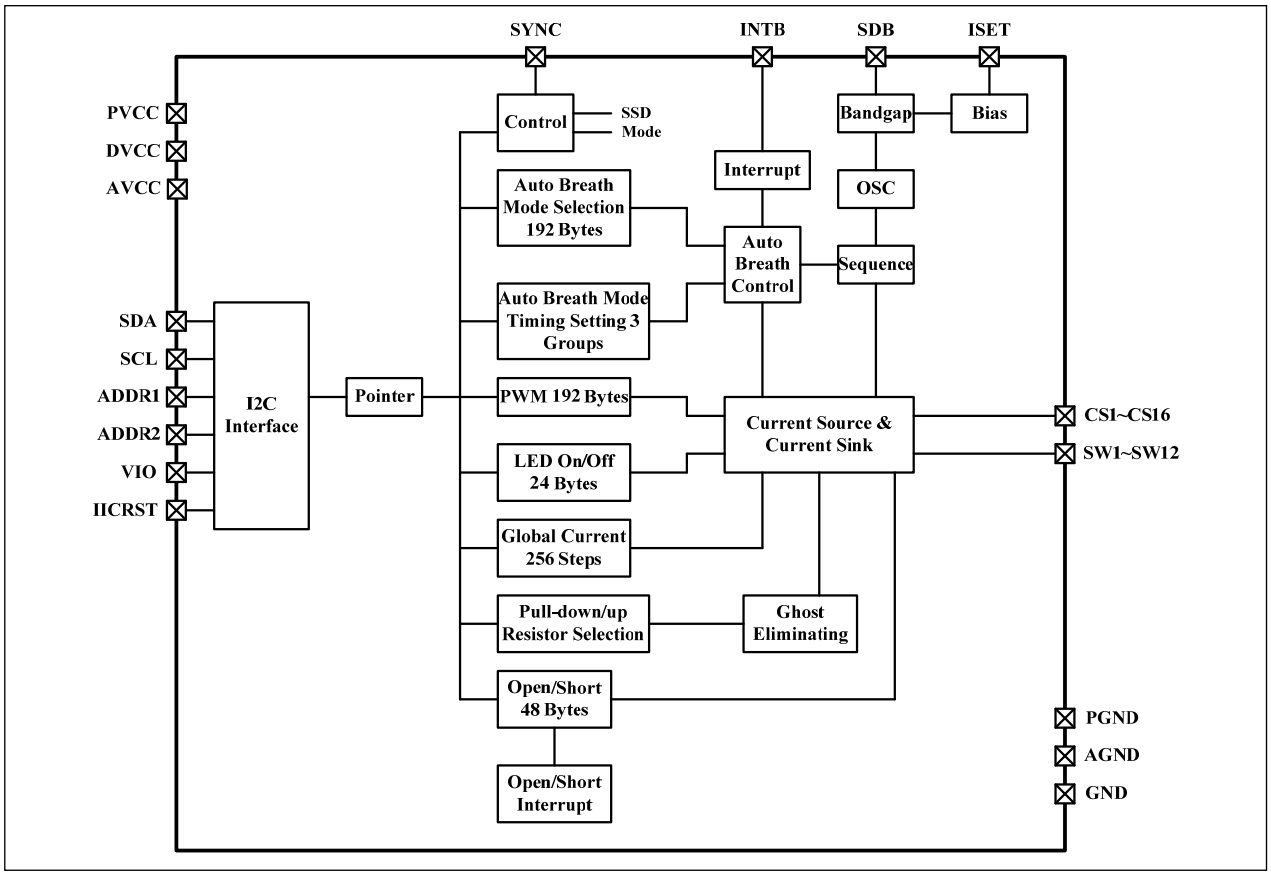
Symbol	Parameter	Fast Mode			Fast Mode Plus			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	
f_{SCL}	Serial-clock frequency	-		400	-		1000	kHz
t_{BUF}	Bus free time between a STOP and a START condition	1.3		-	0.5		-	μs
$t_{HD, STA}$	Hold time (repeated) START condition	0.6		-	0.26		-	μs
$t_{SU, STA}$	Repeated START condition setup time	0.6		-	0.26		-	μs
$t_{SU, STO}$	STOP condition setup time	0.6		-	0.26		-	μs
$t_{HD, DAT}$	Data hold time	-		-	-		-	μs
$t_{SU, DAT}$	Data setup time	100		-	50		-	ns
t_{LOW}	SCL clock low period	1.3		-	0.5		-	μs
t_{HIGH}	SCL clock high period	0.7		-	0.26		-	μs
t_R	Rise time of both SDA and SCL signals, receiving	-		300	-		120	ns
t_F	Fall time of both SDA and SCL signals, receiving	-		300	-		120	ns

Note 6: In case of R_{ISET}= 20kΩ, Global Current Control Register (PG3, 01h) written “1111 1111”, GCC = “1111 1111”.

Note 7: All LEDs are on and PWM = “1111 1111”, GCC = “1111 1111”.

Note 8: Guaranteed by design.

FUNCTIONAL BLOCK DIAGRAM



DETAILED DESCRIPTION

I2C INTERFACE

The IS31FL3733A uses a serial bus, which conforms to the I2C protocol, to control the chip's functions with two wires: SCL and SDA. The IS31FL3733A has a 7-bit slave address (A7:A1), followed by the R/W bit, A0. Set A0 to "0" for a write command and set A0 to "1" for a read command. The value of bits A1 and A2 are decided by the connection of the ADDR1 pin. The value of bits A3 and A4 are decided by the connection of the ADDR2 pin.

The complete slave address is:

Table 1 Slave Address:

ADDR2	ADDR1	A7:A5	A4:A3	A2:A1	A0
GND	GND	101	00	00	0/1
GND	SCL		00	01	
GND	SDA		00	10	
GND	VCC		00	11	
SCL	GND		01	00	
SCL	SCL		01	01	
SCL	SDA		01	10	
SCL	VCC		01	11	
SDA	GND		10	00	
SDA	SCL		10	01	
SDA	SDA		10	10	
SDA	VCC		10	11	
VCC	GND		11	00	
VCC	SCL		11	01	
VCC	SDA		11	10	
VCC	VCC		11	11	

ADDR1/2 connected to GND, (A2:A1)/(A4:A3)=00;
ADDR1/2 connected to VCC, (A2:A1)/(A4:A3)=11;
ADDR1/2 connected to SCL, (A2:A1)/(A4:A3)=01;
ADDR1/2 connected to SDA, (A2:A1)/(A4:A3)=10;

The SCL line is uni-directional. The SDA line is bi-directional (open-collector) with a pull-up resistor (typically 1kΩ). The maximum clock frequency specified by the I2C standard is 1MHz. In this discussion, the master is the microcontroller and the slave is the IS31FL3733A.

The timing diagram for the I2C is shown in Figure 4. The SDA is latched in on the stable high level of the SCL. When there is no interface activity, the SDA line should be held high.

The "START" signal is generated by lowering the SDA signal while the SCL signal is high. The start signal will alert all devices attached to the I2C bus to check the incoming address against their own chip address.

The 8-bit chip address is sent next, most significant bit first. Each address bit must be stable while the SCL level is high.

After the last bit of the chip address is sent, the master checks for the IS31FL3733A's acknowledge. The master releases the SDA line high (through a pull-up resistor). Then the master sends an SCL pulse. If the IS31FL3733A has received the address correctly, then it holds the SDA line low during the SCL pulse. If the SDA line is not low, then the master should send a "STOP" signal (discussed later) and abort the transfer.

Following acknowledge of IS31FL3733A, the register address byte is sent, most significant bit first. IS31FL3733A must generate another acknowledge indicating that the register address has been received.

Then 8-bit of data byte are sent next, most significant bit first. Each data bit should be valid while the SCL level is stable high. After the data byte is sent, the IS31FL3733A must generate another acknowledge to indicate that the data was received.

The "STOP" signal ends the transfer. To signal "STOP", the SDA signal goes high while the SCL signal is high.

ADDRESS AUTO INCREMENT

To write multiple bytes of data into IS31FL3733A, load the address of the data register that the first data byte is intended for. During the IS31FL3733A acknowledge of receiving the data byte, the internal address pointer will increment by one. The next data byte sent to IS31FL3733A will be placed in the new address, and so on. The auto increment of the address will continue as long as data continues to be written to IS31FL3733A (Figure 7).

READING OPERATION

Register FEh, F1h, 18h~45h of Page 0 and 11h of Page 3 can be read.

To read the FEh and F1h, after I2C start condition, the bus master must send the IS32FL3733A device address with the R/$\overline{W}$ bit set to "0", followed by the register address (FEh or F1h) which determines which register is accessed. Then restart I2C, the bus master should send the IS32FL3738 device address with the R/$\overline{W}$ bit set to "1". Data from the register defined by the command byte is then sent from the CHROMA-96 to the master (Figure 8).

To read the 18h~45h of Page 0 and 11h of Page 3, the FDh should write with 00h before follow the Figure 8 sequence to read the data, that means, when you want to read 18h~45h of Page 0 and 11h of Page 3 the FDh should point to Page 0 first and you can read the Page 0 data.

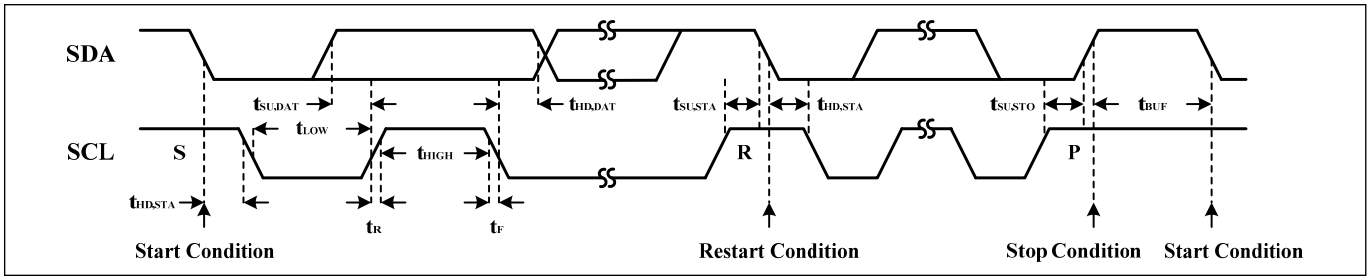


Figure 4 Interface Timing

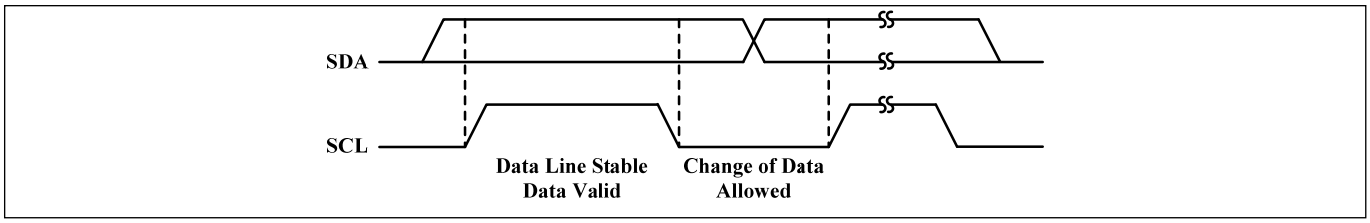


Figure 5 Bit Transfer

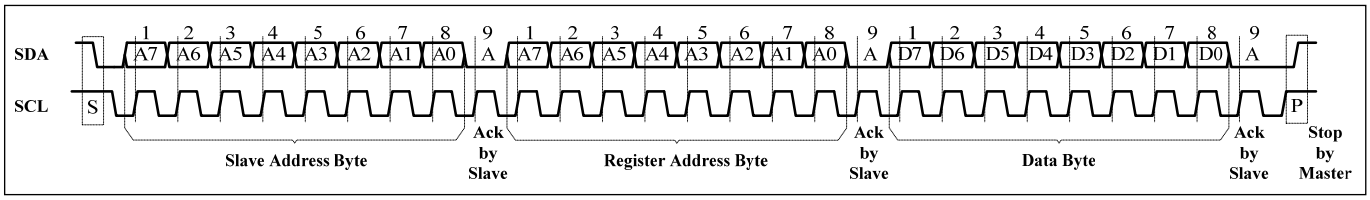


Figure 6 Writing to IS31FL3733A (Typical)

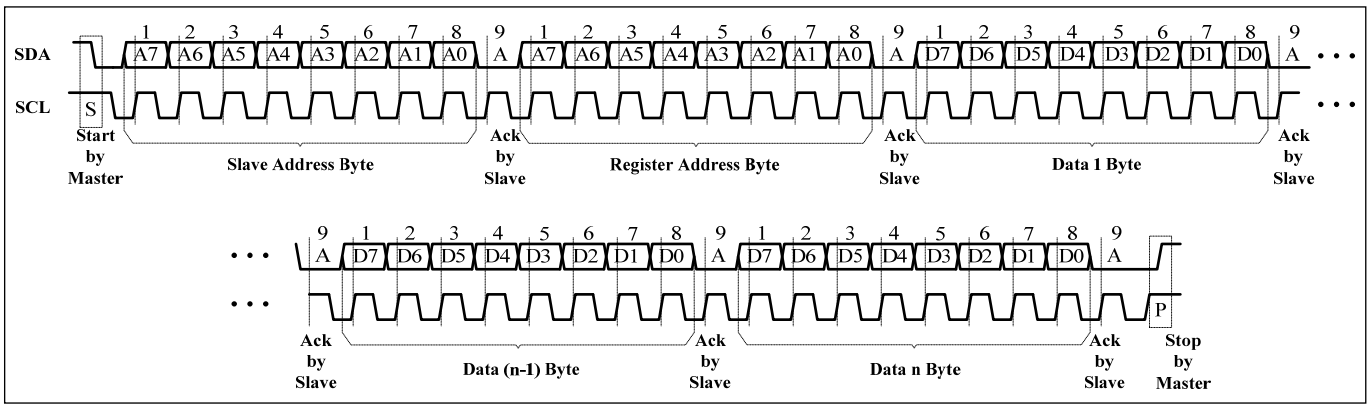


Figure 7 Writing to IS31FL3733A (Automatic Address Increment)

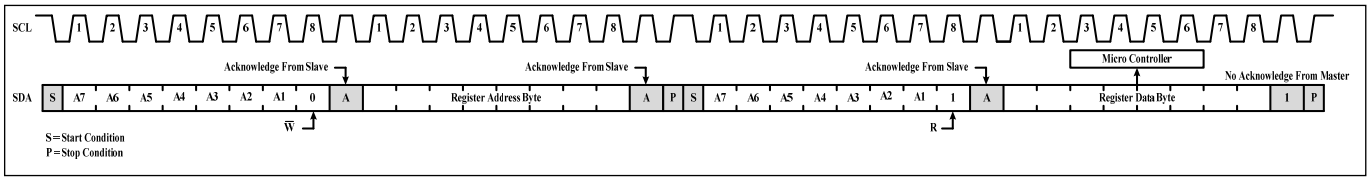


Figure 8 Reading from IS31FL3733A

REGISTER DEFINITION-1

Address	Name	Function	Table	R/W	Default
FDh	Command Register	Available Page 0 to Page 3 Registers	2	W	xxxx xxxx
FEh	Command Register Write lock	To lock/unlock Command Register	3	R/W	0000 0000
F0h	Interrupt Mask Register	Configure the interrupt function	4	W	
F1h	Interrupt Status Register	Show the interrupt status	5	R	

REGISTER CONTROL

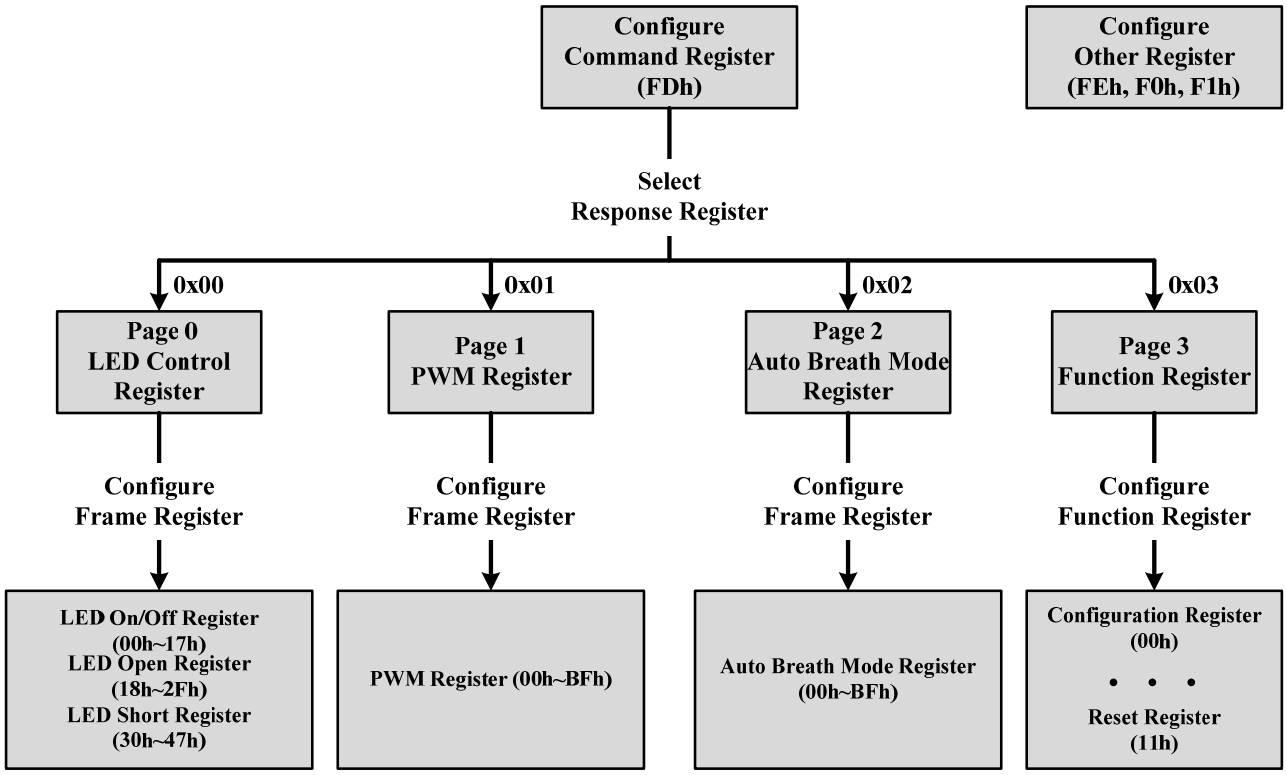


Table 2 FDh Command Register (Write Only)

Data	Function
0000 0000	Point to Page 0 (PG0, LED Control Register is available)
0000 0001	Point to Page 1 (PG1, PWM Register is available)
0000 0010	Point to Page 2 (PG2, Auto Breath Mode Register is available)
0000 0011	Point to Page 3 (PG3, Function Register is available)
Others	Reserved

Note: FDh is locked when power up, need to unlock this register before write command to it. See Table 3 for detail.

The Command Register should be configured first after writing in the slave address to choose the available register. Then write data in the choosing register. Power up default state is "0000 0000".

For example, when write "0000 0001" in the Command Register (FDh), the data which writing after will be stored in PWM Register (Page1).

Table 3 FEh Command Register Write Lock (Read/Write)

Bit	D7:D0
Name	CRWL
Default	0000 0000 (FDh write disable)

To select the PG0~PG3, need to unlock this register first, with the purpose to avoid misoperation of this register. When FEh is written with 0xC5, FDh is allowed to modify once, after the FDh is modified the FEh will reset to be 0x00 at once.

CRWL Command Register Write Lock
0x00 FDh write disable
0xC5 FDh write enable once

Table 4 F0h Interrupt Mask Register (Write Only)

Bit	D7:D4	D3	D2	D1	D0
Name	-	IAC	IAB	IS	IO
Default	0000	0	0	0	0

Configure the interrupt function for IC.

IAC Auto Clear Interrupt Bit
0 Interrupt could not auto clear
1 Interrupt auto clear when INTB stay low exceeds 8ms

IAB Auto Breath Interrupt Bit
0 Disable auto breath loop finish interrupt
1 Enable auto breath loop finish interrupt

IS Dot Short Interrupt Bit
0 Disable dot short interrupt
1 Enable dot short interrupt

IO Dot Open Interrupt Bit
0 Disable dot open interrupt
1 Enable dot open interrupt

Table 5 F1h Interrupt Status Register (Read Only)

Bit	D7:D5	D4	D3	D2	D1	D0
Name	-	ABM3	ABM2	ABM1	SB	OB
Default	000	0	0	0	0	0

Show the interrupt status for IC.

ABM3 Auto Breath Mode 3 Finish Bit
0 ABM3 not finish
1 ABM3 finish

ABM2 Auto Breath Mode 2 Finish Bit
0 ABM2 not finish
1 ABM2 finish

ABM1 Auto Breath Mode 1 Finish Bit
0 ABM1 not finish
1 ABM1 finish

SB Short Bit
0 No short
1 Short happens

OB Open Bit
0 No open
1 Open happens

REGISTER DEFINITION-2

Address	Name	Function	Table	R/W	Default
PG0 (0x00): LED Control Register					
00h ~ 17h	LED On/Off Register	Set on or off state for each LED	7	W	0000 0000
18h ~ 2Fh	LED Open Register	Store open state for each LED	8	R	
30h ~ 47h	LED Short Register	Store short state for each LED	9	R	
PG1 (0x01): PWM Register					
00h~BFh	PWM Register	Set PWM duty for LED	10	W	0000 0000
PG2 (0x02): Auto Breath Mode Register					
00h~BFh	Auto Breath Mode Register	Set operating mode of each dot	11	W	0000 0000
PG3 (0x03) : Function Register					
00h	Configuration Register	Configure the operation mode	13	W	0000 0000
01h	Global Current Control Register	Set the global current	14	W	
02h	Auto Breath Control Register 1 of ABM-1	Set fade in and hold time for breath function of ABM-1	15	W	
03h	Auto Breath Control Register 2 of ABM-1	Set the fade out and off time for breath function of ABM-1	16	W	
04h	Auto Breath Control Register 3 of ABM-1	Set loop characters of ABM-1	17	W	
05h	Auto Breath Control Register 4 of ABM-1	Set loop characters of ABM-1	18	W	
06h	Auto Breath Control Register 1 of ABM-2	Set fade in and hold time for breath function of ABM-2	15	W	
07h	Auto Breath Control Register 2 of ABM-2	Set the fade out and off time for breath function of ABM-2	16	W	
08h	Auto Breath Control Register 3 of ABM-2	Set loop characters of ABM-2	17	W	
09h	Auto Breath Control Register 4 of ABM-2	Set loop characters of ABM-2	18	W	
0Ah	Auto Breath Control Register 1 of ABM-3	Set fade in and hold time for breath function of ABM-3	15	W	
0Bh	Auto Breath Control Register 2 of ABM-3	Set the fade out and off time for breath function of ABM-3	16	W	
0Ch	Auto Breath Control Register 3 of ABM-3	Set loop characters of ABM-3	17	W	
0Dh	Auto Breath Control Register 4 of ABM-3	Set loop characters of ABM-3	18	W	
0Eh	Time Update Register	Update the setting of 02h ~ 0Dh registers	-	W	
0Fh	SWy Pull-Up Resistor Selection Register	Set the pull-up resistor for SWy	19	W	
10h	CSx Pull-Down Resistor Selection Register	Set the pull-down resistor for CSx	20	W	
11h	Reset Register	Reset all register to POR state	-	R	

Table 6 Page 0 (PG0, 0x00): LED Control Register

LED Location		LED On/Off Register		LED Open Register		LED Short Register	
SW1(CS1~ CS8)	SW1(CS9~ CS16)	**00h**	01h	**18h**	19h	**30h**	31h
SW2(CS1~ CS8)	SW2(CS9~ CS16)	**02h**	03h	**1Ah**	1Bh	**32h**	33h
SW3(CS1~ CS8)	SW3(CS9~ CS16)	**04h**	05h	**1Ch**	1Dh	**34h**	35h
SW4(CS1~ CS8)	SW4(CS9~ CS16)	**06h**	07h	**1Eh**	1Fh	**36h**	37h
SW5(CS1~ CS8)	SW5(CS9~ CS16)	**08h**	09h	**20h**	21h	**38h**	39h
SW6(CS1~ CS8)	SW6(CS9~ CS16)	**0Ah**	0Bh	**22h**	23h	**3Ah**	3Bh
SW7(CS1~ CS8)	SW7(CS9~ CS16)	**0Ch**	0Dh	**24h**	25h	**3Ch**	3Dh
SW8(CS1~ CS8)	SW8(CS9~ CS16	**0Eh**	0Fh	**26h**	27h	**3Eh**	3Fh
SW9(CS1~ CS8)	SW9(CS9~ CS16)	**10h**	11h	**28h**	29h	**40h**	41h
SW10(CS1~ CS8)	SW10(CS9~ CS16)	**12h**	13h	**2Ah**	2Bh	**42h**	43h
SW11(CS1~ CS8)	SW11(CS9~ CS16)	**14h**	15h	**2Ch**	2Dh	**44h**	45h
SW12(CS1~ CS8)	SW12(CS9~ CS16)	**16h**	17h	**2Eh**	2Fh	**46h**	47h

Table 7 00h ~ 17h LED On/Off Register

Bit	D7:D0
Name	C_{CS8} : C_{CS1} or C_{CS16} : C_{CS9}
Default	0000 0000

The LED On/Off Registers store the on or off state of each LED in the Matrix.

C_{X-Y} LED State Bit
0 LED off
1 LED on

Table 8 18h ~ 2Fh LED Open Register

Bit	D7:D0
Name	OP_8 : OP_1 or OP_{16} : OP_9
Default	0000 0000

The LED Open Registers store the open or normal state of each LED in the Matrix.

OPx LED Open Bit
0 LED normal
1 LED open

Table 9 30h ~ 47h LED Short Register

Bit	D7:D0
Name	ST_8 : ST_1 or ST_{16} : ST_9
Default	0000 0000

The LED Short Registers store the short or normal state of each LED in the Matrix.

STx LED Short Bit
0 LED normal
1 LED short

Page 1 (PG1, 0x01): PWM Register

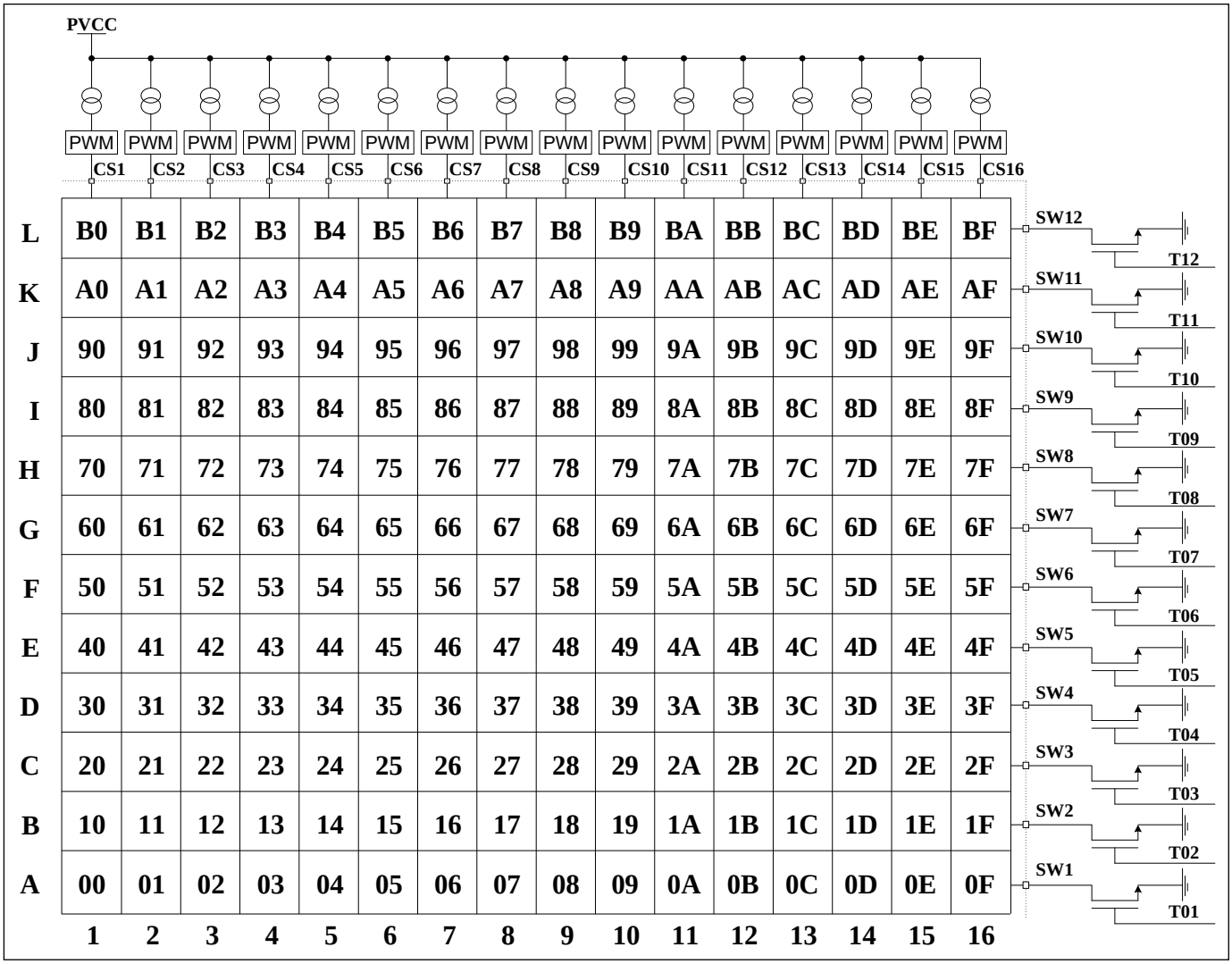


Figure 9 PWM Register

Table 10 00h ~ BFh PWM Register

Bit	D7:D0
Name	PWM
Default	0000 0000

Each dot has a byte to modulate the PWM duty in 256 steps.

The value of the PWM Registers decides the average current of each LED noted I_{LED}.

I_{LED} computed by Formula (1):

$$I_{LED} = \frac{PWM}{256} \times I_{OUT} \times Duty \qquad (1)$$

$$PWM = \sum_{n=0}^{7} D[n] \cdot 2^n$$

Where Duty is the duty cycle of SWy (PFS="0"),

$$Duty = \frac{128\mu s}{(128\mu s + 8\mu s)} \times \frac{1}{12} = \frac{1}{12.75} \qquad (2)$$

I_{OUT} is the output current of CSx (x=1~16),

$$I_{OUT} = \frac{840}{R_{ISET}} \times \frac{GCC}{256} \qquad (3)$$

GCC is the Global Current Control register (PG3, 01h) value and R_{ISET} is the external resistor of ISET pin. D[n] stands for the individual bit value, 1 or 0, in location n.

For example: if D7:D0= 10110101 (0xB5, 181), GCC=255, R_{ISET}=20kΩ (I_{OUT}=42mA),

$$I_{LED} = \frac{2^0 + 2^2 + 2^4 + 2^5 + 2^7}{256} \times I_{OUT} \times \frac{1}{12.75} = 2.34mA$$

Page 2 (PG2, 0x02): Auto Breath Mode Register

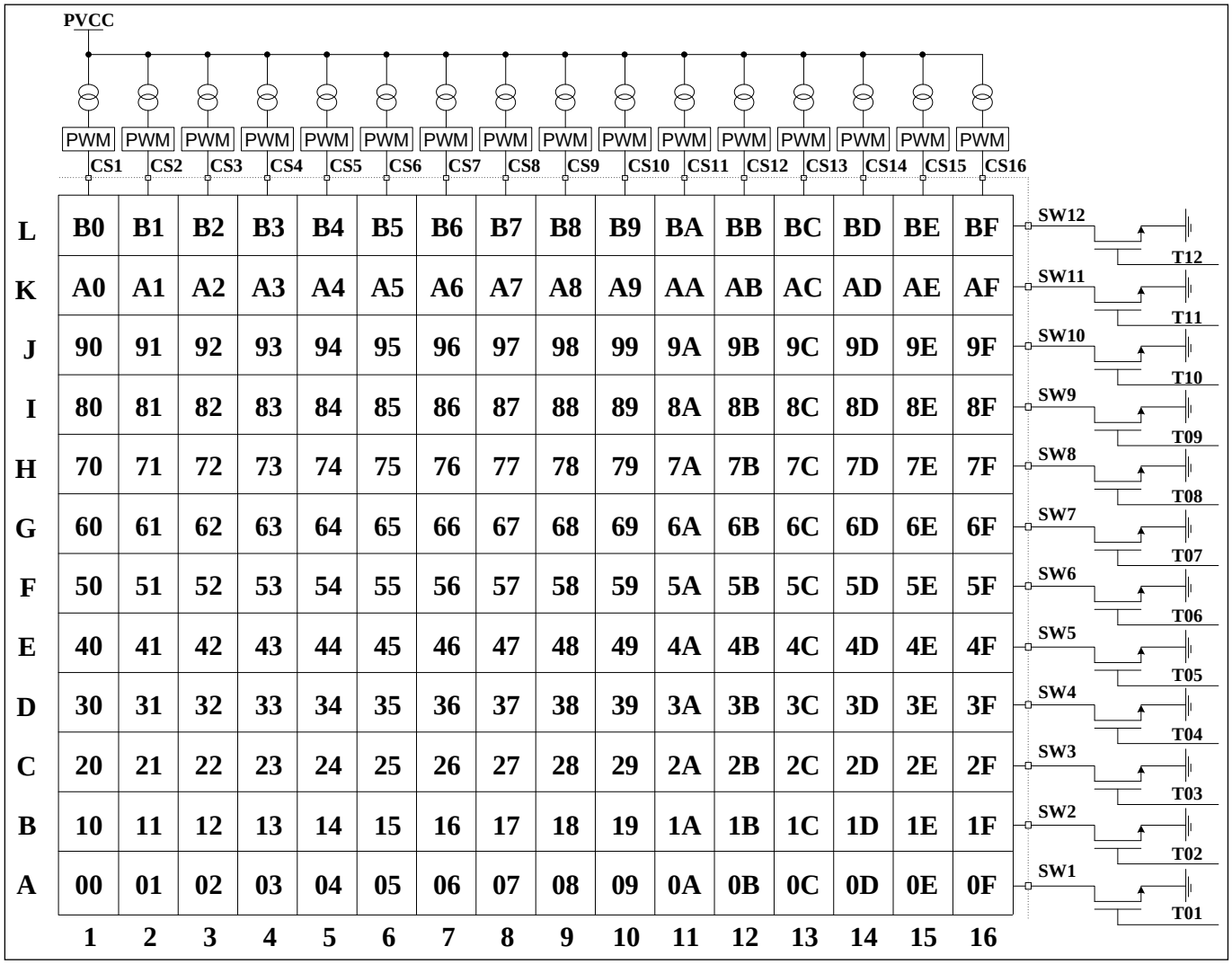


Figure 10 Auto Breath Mode Selection Register

Table 11 00h ~ BFh Auto Breath Mode Register

Bit	D7:D2	D1:D0
Name	-	ABMS
Default	-	00

The Auto Breath Mode Register sets operating mode of each dot.

ABMS Auto Breath Mode Selection Bit
00 PWM control mode
01 Select Auto Breath Mode 1 (ABM-1)
10 Select Auto Breath Mode 2 (ABM-2)
11 Select Auto Breath Mode 3 (ABM-3)

Table 12 Page 3 (PG3, 0x03): Function Register

Register	Name	Function	R/W	Default
00h	Configuration Register	Configure the operation mode	W	0000 0000
01h	Global Current Control Register	Set the global current	W	
02h	Auto Breath Control Register 1 of ABM-1	Set fade in and hold time for breath function of ABM-1	W	
03h	Auto Breath Control Register 2 of ABM-1	Set the fade out and off time for breath function of ABM-1	W	
04h	Auto Breath Control Register 3 of ABM-1	Set loop characters of ABM-1	W	
05h	Auto Breath Control Register 4 of ABM-1	Set loop characters of ABM-1	W	
06h	Auto Breath Control Register 1 of ABM-2	Set fade in and hold time for breath function of ABM-2	W	
07h	Auto Breath Control Register 2 of ABM-2	Set the fade out and off time for breath function of ABM-2	W	
08h	Auto Breath Control Register 3 of ABM-2	Set loop characters of ABM-2	W	
09h	Auto Breath Control Register 4 of ABM-2	Set loop characters of ABM-2	W	
0Ah	Auto Breath Control Register 1 of ABM-3	Set fade in and hold time for breath function of ABM-3	W	
0Bh	Auto Breath Control Register 2 of ABM-3	Set the fade out and off time for breath function of ABM-3	W	
0Ch	Auto Breath Control Register 3 of ABM-3	Set loop characters of ABM-3	W	
0Dh	Auto Breath Control Register 4 of ABM-3	Set loop characters of ABM-3	W	
0Eh	Time Update Register	Update the setting of 02h ~ 0Dh registers	W	
0Fh	SWy Pull-Up Resistor Selection Register	Set the pull-up resistor for Swy	W	
10h	CSx Pull-Down Resistor Selection Register	Set the pull-down resistor for CSx	W	
11h	Reset Register	Reset all register to POR state	R	

Table 13 00h Configuration Register

Bit	D7:D6	D5	D4	D3	D2	D1	D0
Name	SYNC	-	PFS	-	OSD	B_EN	SSD
Default	00	0	0	0	0	0	0

The Configuration Register sets operating mode of IS31FL3733A.

When SYNC bits are set to “01”, the IS31FL3733A is configured as the master clock source and the SYNC pin will generate a clock signal distributed to the clock slave devices. To be configured as a clock slave device and accept an external clock input the slave device’s SYNC bits must be set to “10”.

The PFS bit selects a fixed PWM operating frequency for all CSx, when PFS set “0”, the PWM frequency is 7.4kHz, when PFS set to “1”, the PWM frequency is 25kHz.

When OSD set high, open/short detection will be trigger once, the user could trigger OS detection again by set OSD from “0” to “1”.

When B_EN enable, those dots select working in ABM-x mode will start to run the pre-established timing. If it is disabled, all dots work in PWM mode. Following Figure 16 to enable the Auto Breath mode

When SSD is “0”, IS31FL3733A works in software shutdown mode and to normal operate the SSD bit should set to “1”.

SYNC Synchronize Configuration
00/11 High Impedance
01 Master
10 Slave

PFS PWM Frequency Setting Bit
0 7.4kHz
1 25kHz

OSD Open/Short Detection Enable Bit
0 Disable open/short detection
1 Enable open/short detection

B_EN Auto Breath Enable
0 PWM Mode Enable
1 Auto Breath Mode Enable

SSD Software Shutdown Control
0 Software shutdown
1 Normal operation

Table 14 01h Global Current Control Register

Bit	D7:D0
Name	GCCx
Default	0000 0000

The Global Current Control Register modulates all CSx (x=1~16) DC current which is noted as I_{OUT} in 256 steps.

I_{OUT} is computed by the Formula (3):

$$I_{OUT} = \frac{840}{R_{ISET}} \times \frac{GCC}{256} \qquad (3)$$

$$GCC = \sum_{n=0}^{7} D[n] \cdot 2^n$$

Where D[n] stands for the individual bit value, 1 or 0, in location n, R_{ISET} is the external resistor of ISET pin.

For example: if D7:D0 = 1011 0101,

$$I_{OUT} = \frac{2^0 + 2^2 + 2^4 + 2^5 + 2^7}{256} \times \frac{840}{R_{ISET}}$$

Table 15 02h, 06h, 0Ah Auto Breath Control Register 1 of ABM-x

Bit	D7:D5	D4:D1	D0
Name	T1	T2	-
Default	000	0000	0

Auto Breath Control Register 1 set the T1&T2 time in Auto Breath Mode.

T1 T1 Setting

T1	PFS= “0”	PFS= “1”
000	0.21s	0.07s
001	0.42s	0.14s
010	0.84s	0.28s
011	1.68s	0.56s
100	3.36s	1.12s
101	6.72s	2.24s
110	13.44s	4.48s
111	26.88s	8.96s

T2 T2 Setting

T2	PFS= “0”	PFS= “1”
0000	0s	0s
0001	0.21s	0.07s
0010	0.42s	0.14s
0011	0.84s	0.28s
0100	1.68s	0.56s
0101	3.36s	1.12s
0110	6.72s	2.24s
0111	13.44s	4.48s
1000	26.88s	8.96s
Others		Unavailable

Table 16 03h, 07h, 0Bh Auto Breath Control Register 2 of ABM-x

Bit	D7:D5	D4:D1	D0
Name	T3	T4	-
Default	000	0000	0

Auto Breath Control Register 2 set the T3&T4 time in Auto Breath Mode.

T3 T3 Setting

T3	PFS= “0”	PFS= “1”
000	0.21s	0.07s
001	0.42s	0.14s
010	0.84s	0.28s
011	1.68s	0.56s
100	3.36s	1.12s
101	6.72s	2.24s
110	13.44s	4.48s
111	26.88s	8.96s

T4 T4 Setting

T4	PFS= “0”	PFS= “1”
0000	0s	0s
0001	0.21s	0.07s
0010	0.42s	0.14s
0011	0.84s	0.28s
0100	1.68s	0.56s
0101	3.36s	1.12s
0110	6.72s	2.24s
0111	13.44s	4.48s
1000	26.88s	8.96s
1001	53.76s	17.92s
1010	107.52s	35.84s
Others		Unavailable

Table 17 04h, 08h, 0Ch Auto Breath Control Register 3 of ABM-x

Bit	D7:D6	D5:D4	D3:D0
Name	LE	LB	LTA
Default	00	00	0000

Total loop times= LTA ×256 + LTB.

For example, if LTA=2, LTB=100, the total loop times is 256×2+100= 612 times.

For the counting of breathing times, do follow Figure 16 to enable the Auto Breath Mode.

If the loop start from T4,

T4->T1->T2->T3(1)->T4->T1->T2->T3(2)->T4->T1->... and so on.

If the loop not start from T4,

Tx->T3(1) ->T4->T1->T2->T3(2)->T4-> T1->... and so on.

If the loop ends at off state (End of T3), the LED will be off state at last. If the loop ends at on state (End of T1), the LED will run an extra T4&T1, which are not included in loop.

LB Loop Beginning Time
00 Loop begin from T1
01 Loop begin from T2
10 Loop begin from T3
11 Loop begin from T4

LE Loop End Time
00 Loop end at off state (End of T3)
01 Loop end at on state (End of T1)

LTA 8-11 Bits Of Loop Times
0000 Endless loop
0001 1
0010 2
… …
1111 15

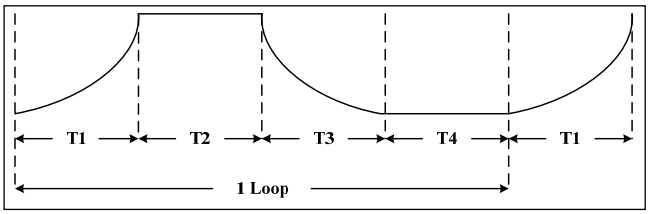


Figure 11 Auto Breathing Function

Table 18 05h, 09h, 0Dh Auto Breath Control Register 4 of ABM-x

Bit	D7:D0
Name	LTB
Default	0000 0000

Total loop times= LTA ×256 + LTB.

For example, if LTA=2, LTB=100, the total loop times is 256×2+100= 612 times.

LTB 0-7 Bits Of Loop Times
0000 0000 Endless loop
0000 0001 1
0000 0010 2
… …
1111 1111 255

0Eh Time Update Register (02h~0Dh)

The data sent to the time registers (02h~0Dh) will be stored in temporary registers. A write operation of “0000 0000” data to the Time Update Register is required to update the registers (02h~0Dh). Please follow Figure 16 to enable the Auto Breath mode and update the time parameters.

Table 19 0Fh SWy Pull-Up Resistor Selection Register

Bit	D7:D3	D2:D0
Name	-	PUR
Default	00000	000

Set pull-up resistor for SWy.

PUR	SWy Pull-up Resistor Selection Bit
000	No pull-up resistor
001	No pull-up resistor
010	No pull-up resistor
011	3.0kΩ pull-up all the time
100	4.0kΩ pull-up all the time
101	8.0kΩ pull-up all the time
110	16kΩ pull-up all the time
111	32kΩ pull-up in t_{NOL}

Table 20 10h CSx Pull-Down Resistor Selection Register

Bit	D7:D3	D2:D0
Name	-	PDR
Default	00000	000

Set the pull-down resistor for CSx.

PDR	CSx Pull-down Resistor Selection Bit
000	No pull-down resistor
001	0.5kΩ pull-down in t_{NOL}
010	0.5kΩ pull-down in t_{NOL}
011	3.0kΩ pull-down all the time
100	4.0kΩ pull-down all the time
101	8.0kΩ pull-down all the time
110	16kΩ pull-down all the time
111	32kΩ pull-down in t_{NOL}

11h Reset Register

Once user read the Reset Register, IS31FL3733A will reset all the IS31FL3733A registers to their default value. On initial power-up, the IS31FL3733A registers are reset to their default values for a blank display.

APPLICATION INFORMATION

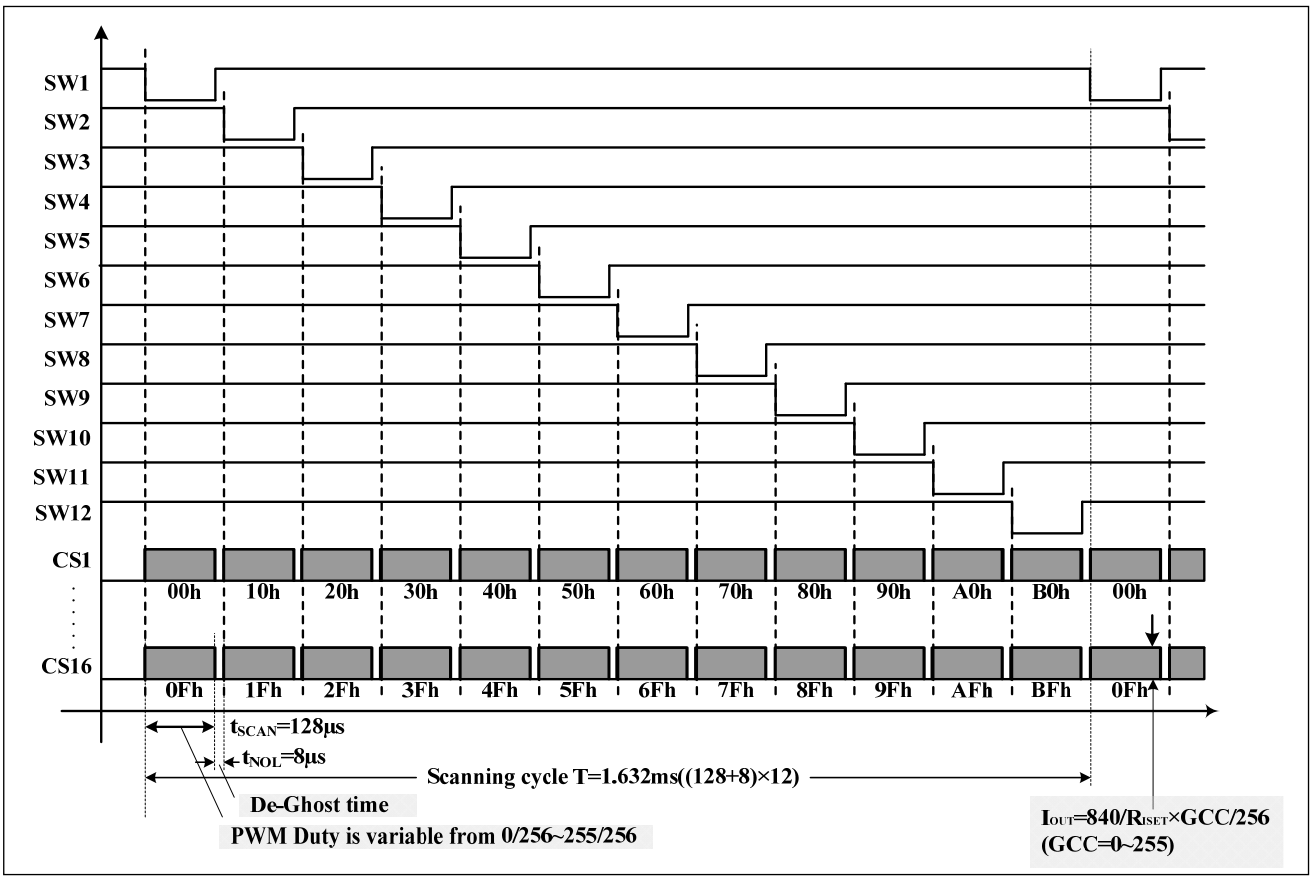


Figure 12 Scanning Timing (PFS="0")

SCANING TIMING

As shown in Figure 12, the SW1~SW12 is turned on by serial, LED is driven 16 by 16 within the SWy (x=1~12) on time (SWy, y=1~12) is sink and pull low when LED on) , including the non-overlap blanking time during scan, the duty cycle of SWy (active low, y=1~12) is (PFS= "0"):

$$Duty = \frac{128\mu s}{(128\mu s + 8\mu s)} \times \frac{1}{12} = \frac{1}{12.75} \qquad (2)$$

Where 128μs is t_{SCAN}, the period of scanning and 8μs is t_{NOL}, the non-overlap time.

When PFS="1", the duty result is same.

EXTERNAL RESISTOR (R_{ISET})

The output current for each CSx can be can be set by a single external resistor, R_{ISET}, as described in Formula (3).

$$I_{OUT} = \frac{840}{R_{ISET}} \times \frac{GCC}{256} \qquad (3)$$

GCC is Global Current Control Register (PG3, 01h) data showing in Table 14.

PWM CONTROL

After setting the I_{OUT} and GCC, the brightness of each LEDs (LED average current (I_{LED})) can be modulated with 256 steps by PWM Register, as described in Formula (1).

$$I_{LED} = \frac{PWM}{256} \times I_{OUT} \times Duty \qquad (1)$$

Where PWM is PWM Registers (PG1, 00h~BFh) data showing in Table 10.

For example, in Figure 1, R_{ISET}=20kΩ, if PWM=255, and GCC=255, then

$$I_{LED} = \frac{255}{256} \times \frac{840}{20k\Omega} \times \frac{255}{256} \times \frac{1}{12.75} = 3.29mA$$

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

LED AVERAGE CURRENT (I_{LED})

As described in Formula (1), the LED average current (I_{LED}) is effected by 3 factors:

1. R_{ISET}, resistor which is connected ISET pin and GND. R_{ISET} sets the current of all CSx (x=1~16) based on Formula (3).

2. Global Current Control Register (PG3, 01h). This register adjusts all CSx (x=1~16) output currents by 256 steps as shown in Formula (3).

3. PWM Registers (PG1, 00h~BFh), every LED has an own PWM register. PWM Registers adjust individual LED average current by 256 steps as shown in Formula (1).

GAMMA CORRECTION

In order to perform a better visual LED breathing effect we recommend using a gamma corrected PWM value to set the LED intensity. This results in a reduced number of steps for the LED intensity setting, but causes the change in intensity to appear more linear to the human eye.

Gamma correction, also known as gamma compression or encoding, is used to encode linear luminance to match the non-linear characteristics of display. Since the IS31FL3733A can modulate the brightness of the LEDs with 256 steps, a gamma correction function can be applied when computing each subsequent LED intensity setting such that the changes in brightness matches the human eye's brightness curve.

Table 21 32 Gamma Steps with 256 PWM Steps

C(0)	C(1)	C(2)	C(3)	C(4)	C(5)	C(6)	C(7)
0	1	2	4	6	10	13	18
C(8)	C(9)	C(10)	C(11)	C(12)	C(13)	C(14)	C(15)
22	28	33	39	46	53	61	69
C(16)	C(17)	C(18)	C(19)	C(20)	C(21)	C(22)	C(23)
78	86	96	106	116	126	138	149
C(24)	C(25)	C(26)	C(27)	C(28)	C(29)	C(30)	C(31)
161	173	186	199	212	226	240	255

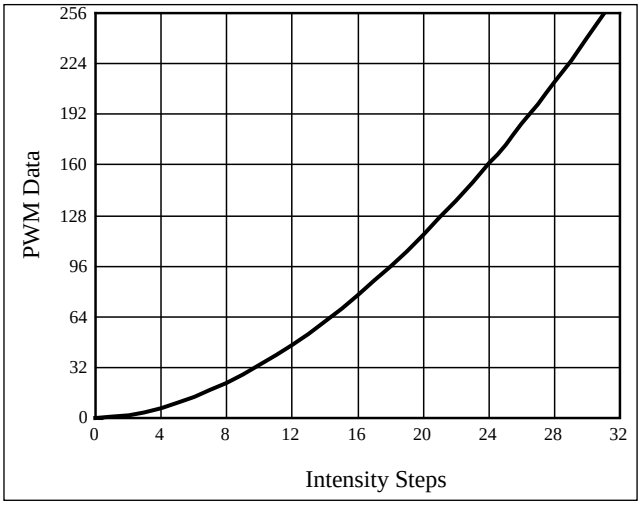


Figure 13 Gamma Correction (32 Steps)

Choosing more gamma steps provides for a more continuous looking breathing effect. This is useful for very long breathing cycles. The recommended configuration is defined by the breath cycle T. When T=1s, choose 32 gamma steps, when T=2s, choose 64 gamma steps. The user must decide the final number of gamma steps not only by the LED itself, but also based on the visual performance of the finished product.

Table 22 64 Gamma Steps with 256 PWM Steps

C(0)	C(1)	C(2)	C(3)	C(4)	C(5)	C(6)	C(7)
0	1	2	3	4	5	6	7
C(8)	C(9)	C(10)	C(11)	C(12)	C(13)	C(14)	C(15)
8	10	12	14	16	18	20	22
C(16)	C(17)	C(18)	C(19)	C(20)	C(21)	C(22)	C(23)
24	26	29	32	35	38	41	44
C(24)	C(25)	C(26)	C(27)	C(28)	C(29)	C(30)	C(31)
47	50	53	57	61	65	69	73
C(32)	C(33)	C(34)	C(35)	C(36)	C(37)	C(38)	C(39)
77	81	85	89	94	99	104	109
C(40)	C(41)	C(42)	C(43)	C(44)	C(45)	C(46)	C(47)
114	119	124	129	134	140	146	152
C(48)	C(49)	C(50)	C(51)	C(52)	C(53)	C(54)	C(55)
158	164	170	176	182	188	195	202
C(56)	C(57)	C(58)	C(59)	C(60)	C(61)	C(62)	C(63)
209	216	223	230	237	244	251	255

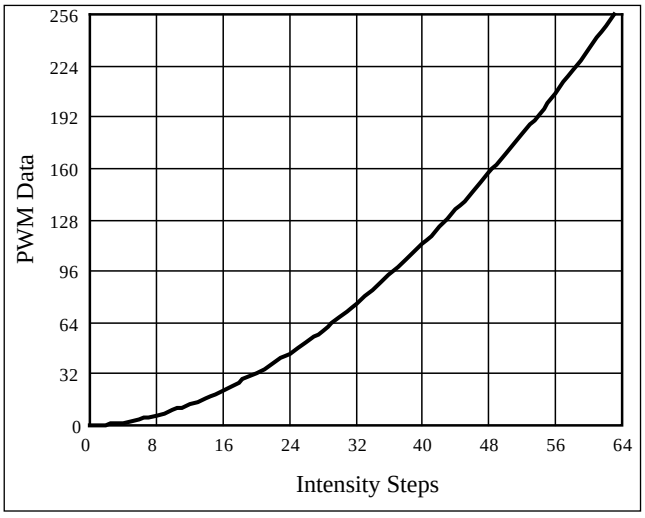


Figure 14 Gamma Correction (64 Steps)

Note: The data of 32 gamma steps is the standard value and the data of 64 gamma steps is the recommended value.

OPERATING MODE

Each dot of IS31FL3733A has two selectable operating modes, PWM Mode and Auto Breath Mode.

PWM Mode

By setting the Auto Breath Mode Register bits of the Page 2 (PG2, 00h~BFh) to "00", or disable the B_EN bit of Configure Register (PG3, 00h), the

IS31FL3733A operates in PWM Mode. The brightness of each LED can be modulated with 256 steps by PWM registers. For example, if the data in PWM Register is “0000 0100”, then the PWM is the fourth step.

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

Auto Breath Mode

By setting the B_EN bit of the Configuration Register (PG3, 00h) to “1”, breath function enables. When set the B_EN bit to “0”, breath function disables.

By setting the Auto Breath Mode Register bits of the Page 2 (PG2, 00h~BFh) to “01” (ABM-1), “10” (ABM-2) or “11” (ABM-3), the IS31FL3733A operates in Auto Breath Mode.

IS31FL3733A has three auto breath modes, Auto Breath Mode 1, Auto Breath Mode 2 and Auto Breath Mode 3. Each ABM has T1, T2, T3 and T4, as shown below:

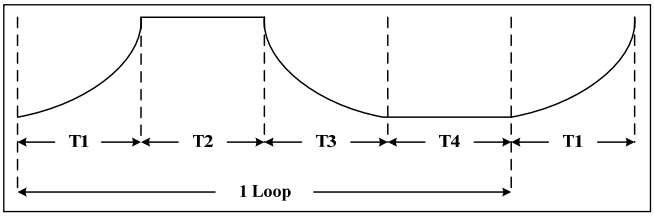


Figure 15 Auto Breathing Function

T1/T3 is variable from 0.21s to 26.88s, T2/T4 is variable from 0s to 26.88s, for each loop, the start point can be T1~T4 and the stop point can be on state (T2) and off state (T4), also the loop time can be set to $1\sim2^{12}$ times or endless. Each LED can select ABM-1~ABM-3 to work.

The setting of ABM-1~ABM-3 (PG2, 02h~0Dh) need to write the 0Eh in PG3 to update before effective.

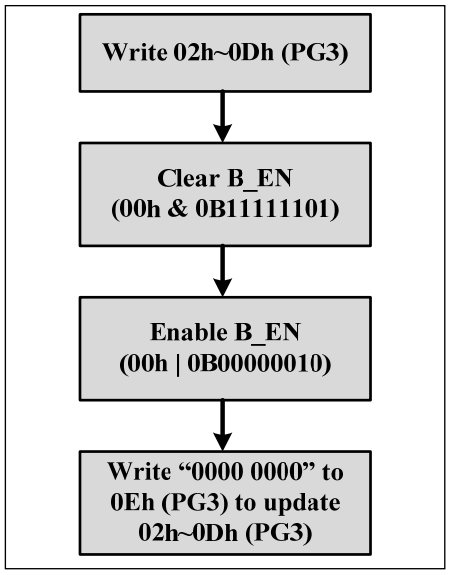


Figure 16 Enable Auto Breath Mode

If not follow this flow, first loop’s start point may be wrong.

OPEN/SHORT DETECT FUNCTION

IS31FL3733A has open and short detect bit for each LED.

By setting the OSD bit of the Configuration Register (PG3, 00h) from “0” to “1”, the LED Open Register and LED Short Register will start to store the open/short information and after at least 2 scanning cycle (3.264ms) the MCU can get the open/short information by reading the 18h~2fh/30h~47h, for those dots are turned off via LED On/Off Registers (PG0, 00h~17h), the open/short data will not get refreshed when setting the OSD bit of the Configuration Register (PG3, 00h) from “0” to “1”.

The Global Current Control Register (PG3, 01h) need to set to 0x01 in order to get the right open/short data.

The detect action is one-off event and each time before reading out the open/short information, the OSD bit of the Configuration Register (PG3, 00h) need to be set from “0” to “1” (clear before set operation).

INTERRUPT CONTROL

IS31FL3733A has an INTB pin, by setting the Interrupt Mask Register (F0h), it can be the flag of LED open, LED short or the finish flag of ABM-1, ABM-2, and ABM-3.

For example, if the IO bit of the Interrupt Mask Register (F0h) set to “1”, when LED open happens, the INTB will pull be pulled low and the OB bit of Interrupt Status Register (F1h) will store open status at the same time.

The INTB pin will be pulled high after reading the Interrupt Status Register (F1h) operation or it will be pulled high automatically after it stays low for 8ms (Typ.) if the IAC bit of Interrupt Mask Register (F0h) is set to “1”. The bits of Interrupt Status Register (F1h) will be reset to “0” after INTB pin pulled high.

SYNCHRONIZE FUNCTION

SYNC bits of the Configuration Register (PG3, 00h) sets SYNC pin input or output synchronize clock signal. It is used for more than one part working synchronize. When SYNC bits are set to “01”, SYNC pin output synchronize clock to synchronize other parts as master. When SYNC bits are set to “10”, SYNC pin input synchronize clock and work synchronization with this input signal as slave. When SYNC bits are set to “00/11”, SYNC pin is high impedance, and synchronize function is disabled. SYNC bit default state is “00” and SYNC pin is high impedance when power up.

DE-GHOST FUNCTION

The “ghost” term is used to describe the behavior of an LED that should be OFF but instead glows dimly when another LED is turned ON. A ghosting effect typically can occur when multiplexing LEDs. In matrix architecture any parasitic capacitance found in the constant-current outputs or the PCB traces to the LEDs may provide sufficient current to dimly light an LED to create a ghosting effect.

To prevent this LED ghost effect, the IS31FL3733A has integrated pull-up resistors for each SWy (y=1~12) and pull-down resistors for each CSx (x=1~16). Select the right SWy pull-up resistor (PG3, 0Fh) and CSx pull-down resistor (PG3, 10h) which eliminates the ghost LED for a particular matrix layout configuration.

Typically, selecting the 32kΩ will be sufficient to eliminate the LED ghost phenomenon.

The SWy pull-up resistors and CSx pull-down resistors are active only when the CSx/SWy outputs are in the OFF state and therefore no power is lost through these resistors

I2C RESET

The I2C will be reset if the IICRST pin is pull-high, when normal operating the I2C bus, the IICRST pin need to keep low.

SHUTDOWN MODE

Shutdown mode can be used as a means of reducing power consumption. During shutdown mode all registers retain their data.

Software Shutdown

By setting SSD bit of the Configuration Register (PG3, 00h) to “0”, the IS31FL3733A will operate in software shutdown mode. When the IS31FL3733A is in software shutdown, all current sources are switched off, so that the matrix is blanked. All registers can be operated. Typical current consume is 3μA.

Hardware Shutdown

The chip enters hardware shutdown when the SDB pin is pulled low. All analog circuits are disabled during hardware shutdown, typical the current consume is 3μA.

The chip releases hardware shutdown when the SDB pin is pulled high. During hardware shutdown state Function Register can be operated.

If V_{CC} has risk drop below 1.75V but above 0.1V during SDB pulled low, please re-initialize all Function Registers before SDB pulled high.

POWER DISSIPATION

The power dissipation of the IS31FL3733A can calculate as below:

$$P_{3733A}=I_{PVCC}\times PV_{CC}+ I_Q\times DV_{CC}(AV_{CC}) - I_{PVCC}\times V_{F(AVR)} \quad (4)$$

$$\approx I_{PVCC}\times PV_{CC} - I_{PVCC}\times V_{F(AVR)}$$

$$\approx I_{PVCC}\times (PV_{CC} - V_{F(AVR)})$$

Where I_{PVCC} is the current of PVCC and $V_{F(AVR)}$ is the average forward of all the LED.

For example, if R_{ISET}=20kΩ, GCC=255, PWM=255, PV_{CC}=5V, $V_{F(AVR)}$=3.5V@42mA,

then the I_{PVCC}=42mA×16×12/12.75=632.5mA.

P_{3733A}=632.5mA×(5V-3.5V)=0.948.75W

When operating the chip at high ambient temperatures, or when driving maximum load current, care must be taken to avoid exceeding the package power dissipation limits. The maximum power dissipation can be calculated using the following Equation (5):

$$P_{D(MAX)} = \frac{125°C - 25°C}{\theta_{JA}} \quad (5)$$

So, $$P_{D(MAX)} = \frac{125°C - 25°C}{39°C/W} \approx 2.56W\,(eTQFP)$$

And, $$P_{D(MAX)} = \frac{125°C - 25°C}{37.5°C/W} \approx 2.67W\,(QFN)$$

Figure 17 and 18, shows the power derating of the IS31FL3733A on a JEDEC boards (in accordance with JESD 51-5 and JESD 51-7) standing in still air.

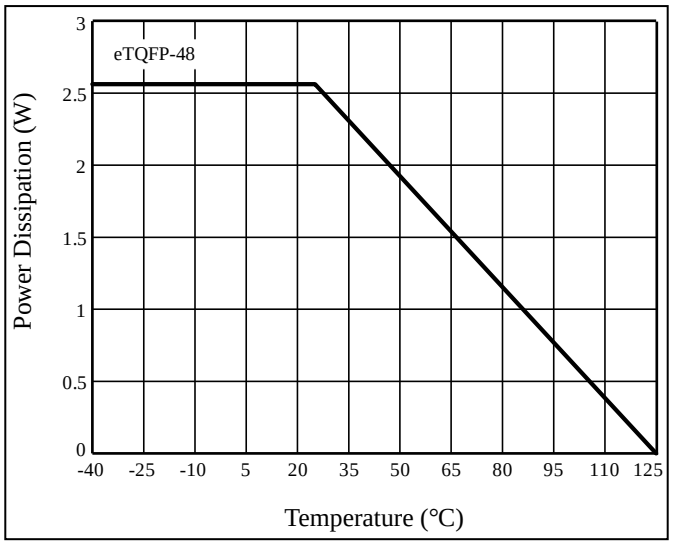


Figure 17 Dissipation Curve

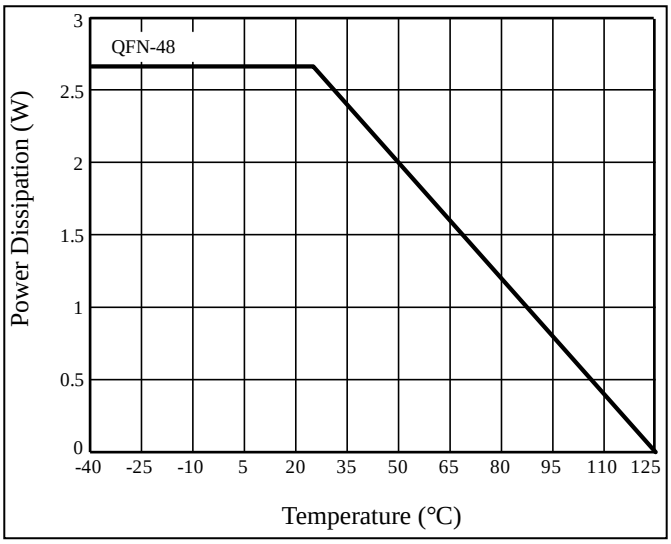


Figure 18 Dissipation Curve

LAYOUT

As described in external resistor (R_{ISET}), the chip consumes lots of power. Please consider below factors when layout the PCB.

1. The V_{CC} (PVCC, DVCC, AVCC, VIO) capacitors need to close to the chip and the ground side should well connected to the GND of the chip.

2. R_{ISET} should be close to the chip and the ground side should well connect to the GND of the chip.

3. The thermal pad should connect to ground pins and the PCB should have the thermal pad too, usually this pad should have 16 or 25 via thru the PCB to other side's ground area to help radiate the heat. About the thermal pad size, please refer to the land pattern of each package.

4. The CSx pins maximum current is 42mA (R_{ISET}=20kΩ), and the SWy pins maximum current is 672mA (R_{ISET}=20kΩ), the width of the trace, SWy should have wider trace then CSx.

5. In the middle of SDA and SCL trace, a ground line is recommended to avoid the effect between these two lines.

PWM FREQUENCY SELECT

The IS31FL3733A output channels operate with a default PWM frequency of 7.4kHz. Because all the CSx channels are synchronized, the DC supply will experience large instantaneous current surges when the CSx channels turn ON. These current surges will generate an AC ripple on the power supply which cause stress to the decoupling capacitors.

When the AC ripple is applied to a monolithic ceramic capacitor chip (MLCC) it will expand and contract causing the PCB to flex and generate audible hum in the range of between 20Hz to 20kHz, to avoid this hum, there are many countermeasures, such as selecting the capacitor type and value which will not cause the PCB to flex and contract.

An additional option for avoiding audible hum is to set the IS31FL3733A's output PWM frequency above the audible range. The Output Frequency Setting Register (00h)'s bit D4 can be used to set the switching frequency to 25kHz, which is beyond the audible range. Figure 19 below shows the variation of output PWM frequency across supply voltage and temperature.

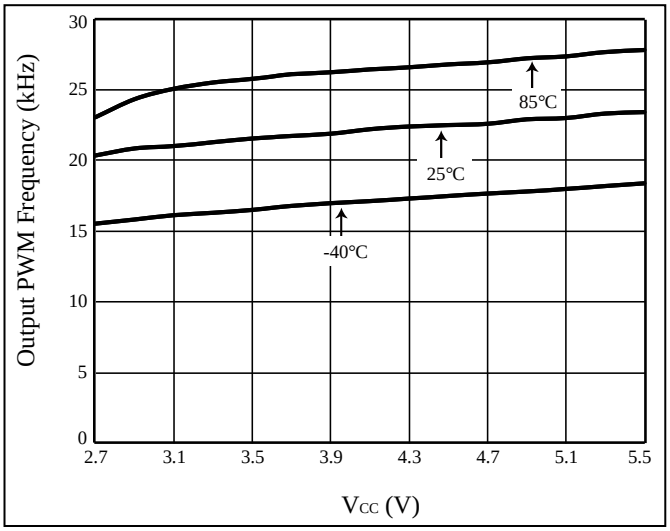


Figure 19 V_{CC} vs. CSx PWM Frequency

CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3°C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217°C 60-150 seconds
Peak package body temperature (Tp)*	Max 260°C
Time (tp)** within 5°C of the specified classification temperature (Tc)	Max 30 seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

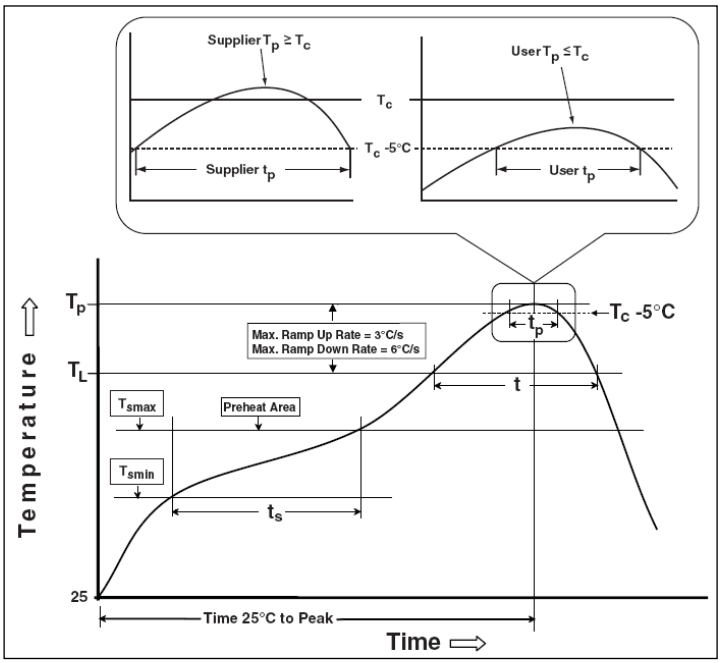
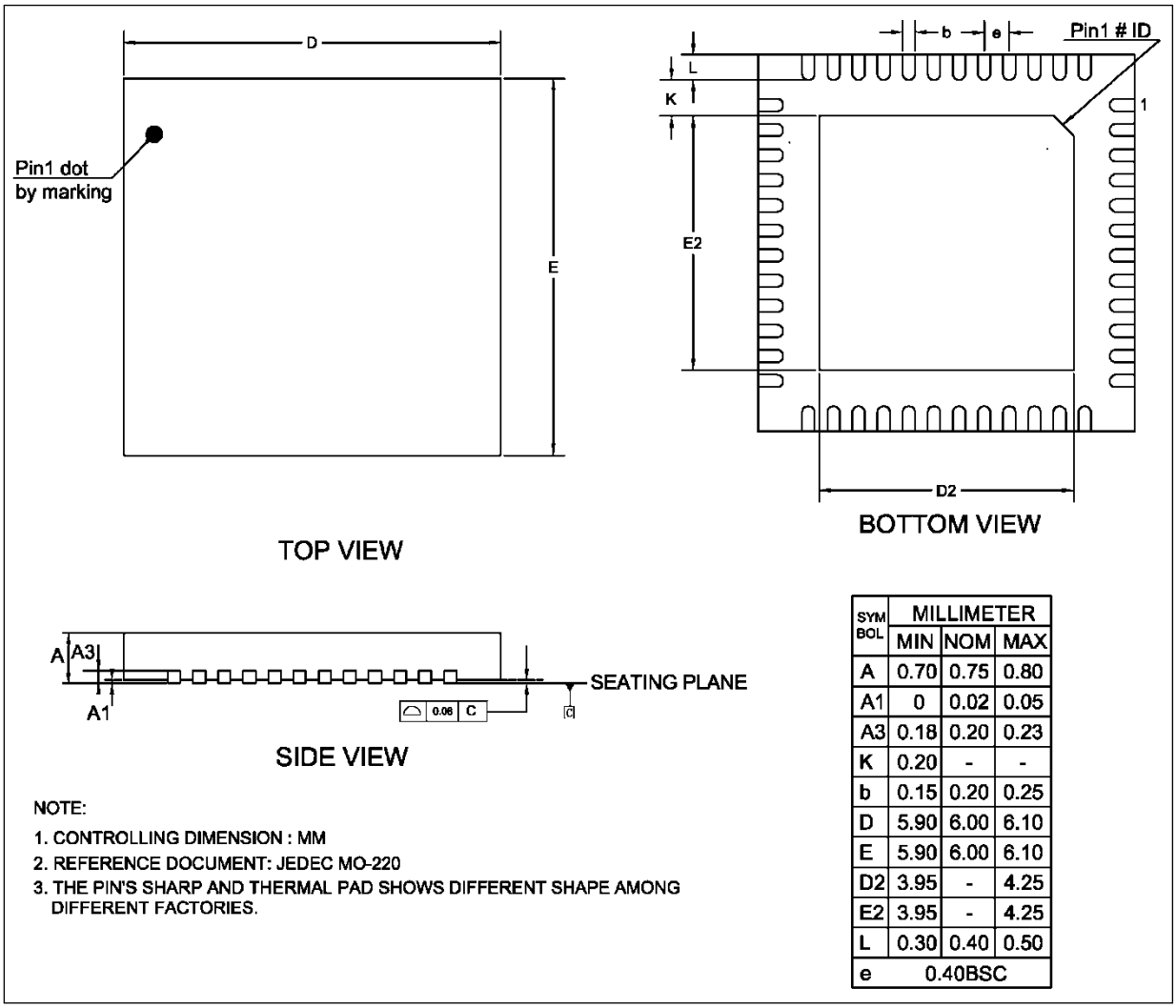


Figure 20 Classification Profile

PACKAGE INFORMATION

QFN-48

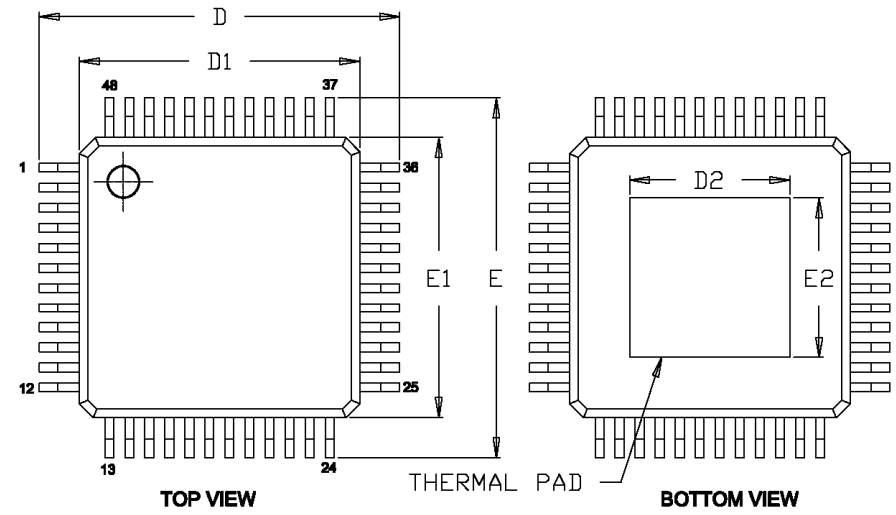


NOTE:

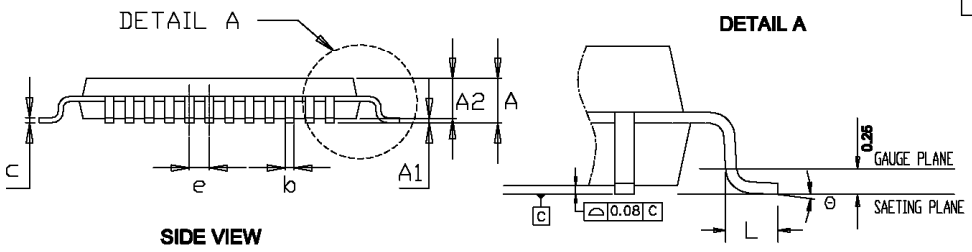
1. CONTROLLING DIMENSION : MM
2. REFERENCE DOCUMENT: JEDEC MO-220
3. THE PIN'S SHARP AND THERMAL PAD SHOWS DIFFERENT SHAPE AMONG DIFFERENT FACTORIES.

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
A3	0.18	0.20	0.23
K	0.20	-	-
b	0.15	0.20	0.25
D	5.90	6.00	6.10
E	5.90	6.00	6.10
D2	3.95	-	4.25
E2	3.95	-	4.25
L	0.30	0.40	0.50
e	0.40BSC		

eTQFP-48



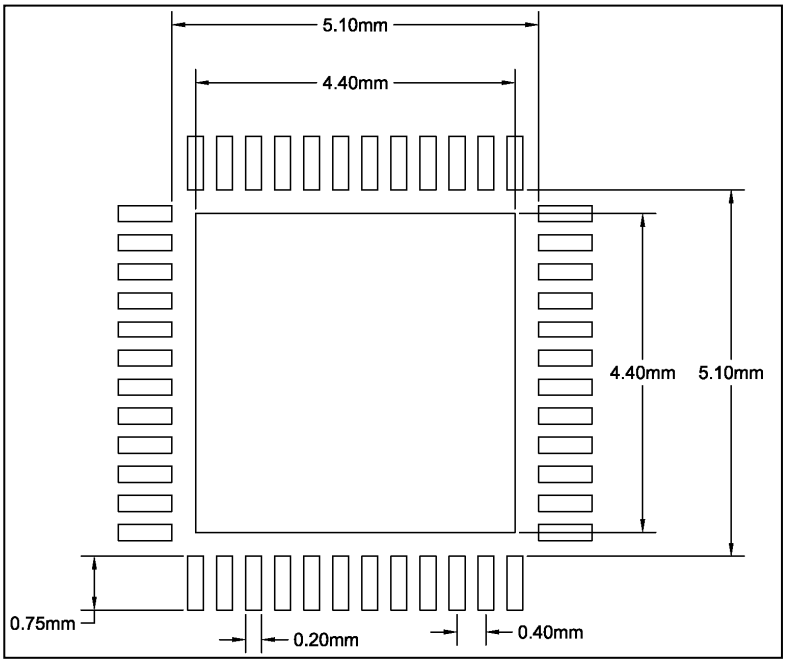
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
D		9.00 BSC	
D1		7.00 BSC	
D2	4.00	—	4.21
E		9.00 BSC	
E1		7.00 BSC	
E2	4.00	—	4.21
L	0.45	0.60	0.75
b	0.17	0.22	0.27
e		0.50 BSC	
c	0.09	—	0.20
θ	0°	—	7°



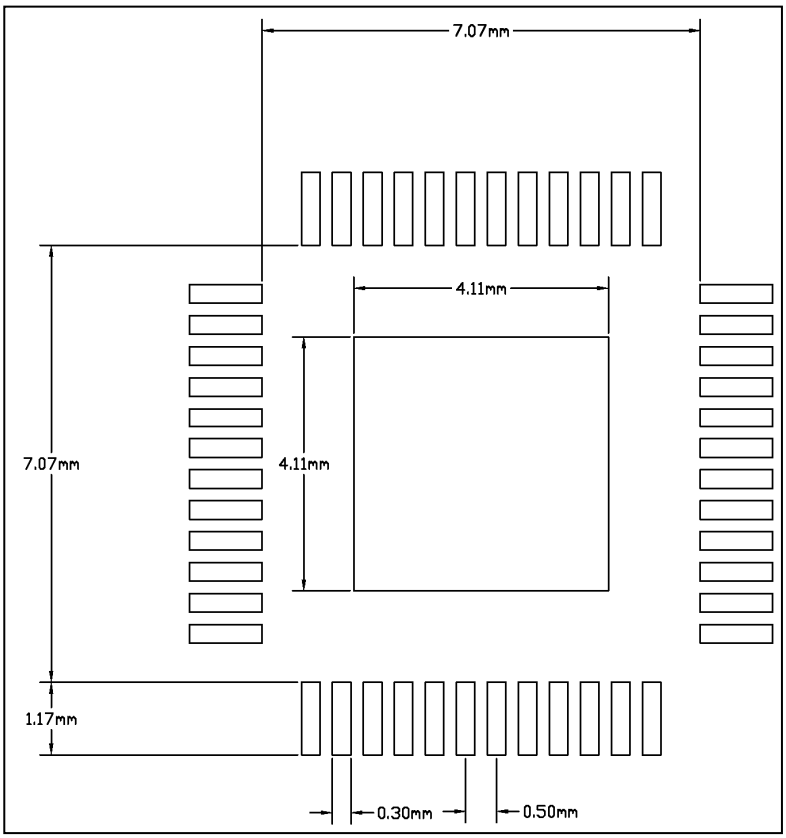
NOTES:
The thermal pad shows different shape among different factories.

RECOMMENDED LAND PATTERN

QFN-48



eTQFP-48



Note:

1. Land pattern complies to IPC-7351.
2. All dimensions in MM.
3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. User's board manufacturing specs), user must determine suitability for use.

REVISION HISTORY

Revision	Detail Information	Date
A	Initial release	2018.12.14
B	Add 2500/Reel for eTQFP package	2020.07.23